

# **1SS86**

## Silicon Schottky Barrier Diode for UHF TV Tuner Mixer

REJ03G0614-0300

(Previous: ADE-208-186B)

Rev.3.00

May 09, 2005

### **Features**

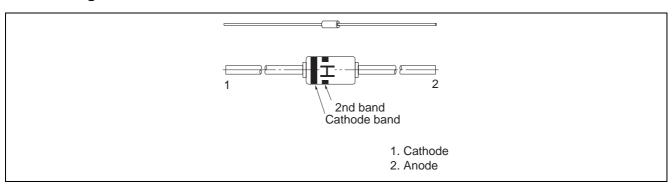
• Low capacitance. (C = 0.85 pF max)

• High reliability with glass seal.

## **Ordering Information**

Type No.	Cathode band	2nd band	Mark	Package Name	Package Code (Previous Code)
1SS86	White	White	Н	DO-35	GRZZ0002ZB-A
					(DO-35)

### **Pin Arrangement**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit	
Reverse voltage	$V_R$	3	V	
Average rectified current	Io	30	mA	
Power dissipation	Pd	150	mW	
Junction temperature	Tj	100	°C	
Storage temperature	Tstg	−55 to +100	°C	

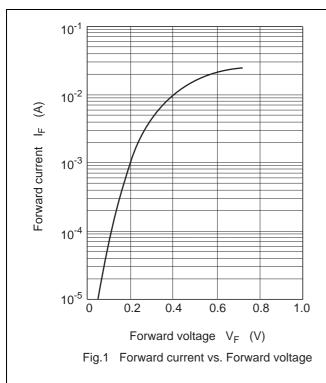
## **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Forward current	I <sub>F</sub>	8	_	_	mA	V <sub>F</sub> = 0.5 V
Reverse current	I <sub>R</sub>	_	_	50	μΑ	V <sub>R</sub> = 0.5 V
Reverse voltage	V <sub>R</sub>	3.0	_	_	V	I <sub>R</sub> = 1 mA
Capacitance	С	_	_	0.85	pF	V <sub>R</sub> = 0.5 V, f = 1 MHz
ESD-Capability *		30	_	_	V	C = 200 pF, R = 0 $\Omega$ , Both forward and reverse direction 1 pulse.

Note: Failure criterion ;  $I_R > 50 \mu A$  at  $V_R = 0.5 V$ 

### **Main Characteristic**



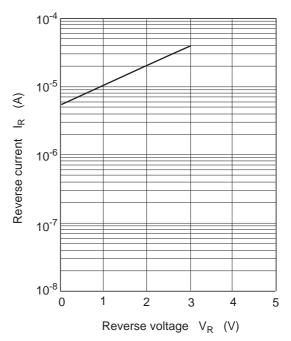
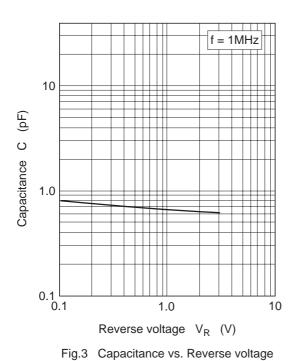
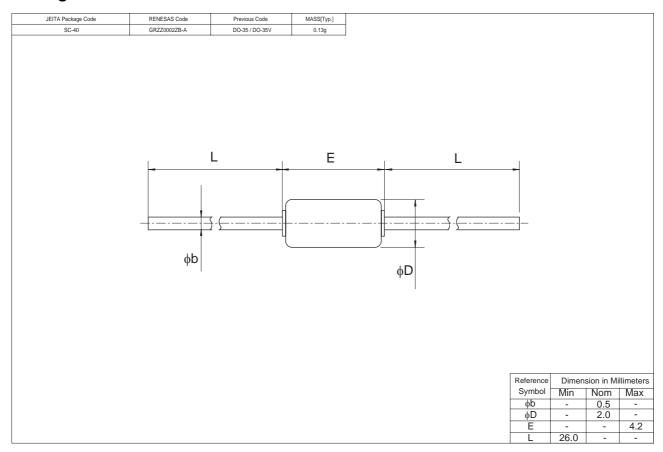


Fig.2 Reverse current vs. Reverse voltage



## **Package Dimensions**



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